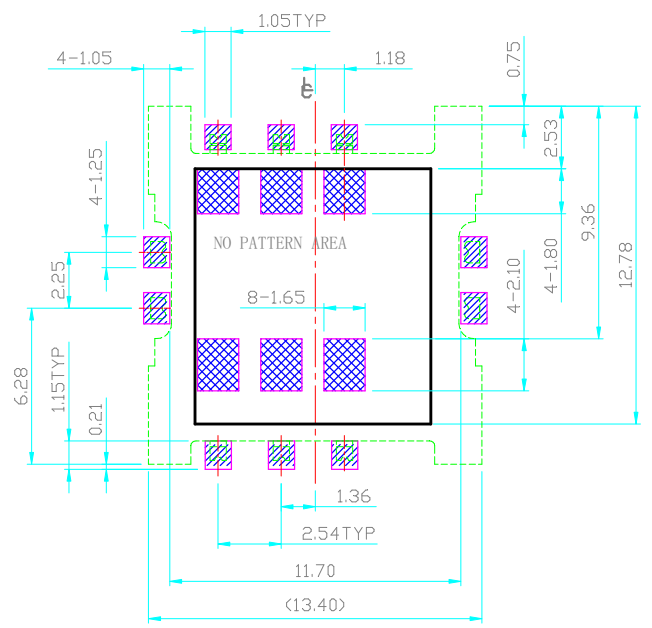
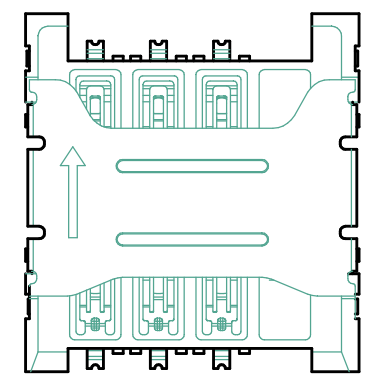
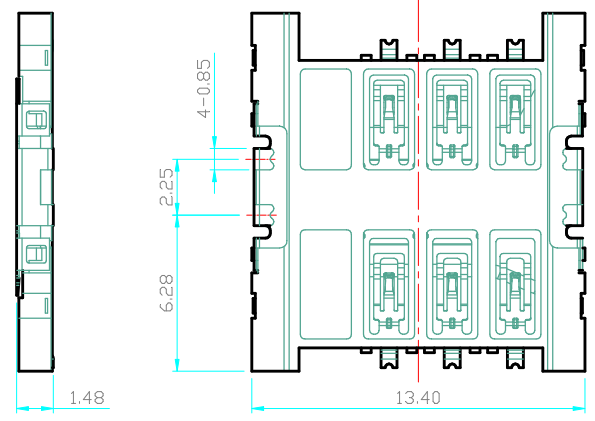
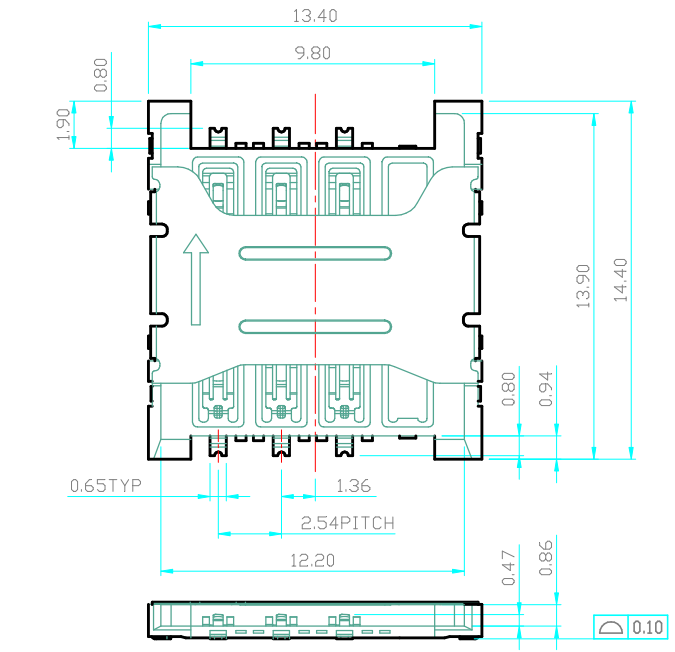
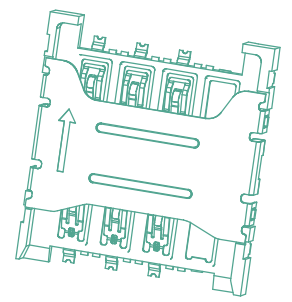


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2011/10/31



RECOMMENDED P.C.B. LAYOUT
TOLERANCE: ±0.05 TOP VIEW

- PCB AREA
- CONNECT AREA
- KEEP OUT AREA



MATERIALS

- HOUSING : THERMOPLASTIC (UL 94V-0) .
- TERMINAL : COPPER ALLOY,
PLATING : GOLD PLATED ON CONTACT AREA
AND SOLDER TAILS,NICKEL PLATED OVERALL.
- SHELL : STAINLESS STEEL.
PLATING : NICKEL PLATED OVERALL.
GOLD PLATED ON SOLDER TAILS

SPECIFICATION

- CURRENT RATING : 1.0 A MAX.
- DIELECTRIC WITHSTANDING VOLTAGE :
500V AC R.M.S. FOR ONE MINUTE.
- INSULATION RESISTANCE : 1000MΩ MIN. AT 500V DC.
- CONTACT RESISTANCE : 30mΩ MAX.
- OPERATING TEMPERATURE : -40°C TO +85°C.

DESCRIPTION OF PLATING ON TERMINALS			
NO.	EXPLAIN	NO.	EXPLAIN
0	GOLD FLASH	3	GOLD 15u''
1	GOLD 5u''	4	GOLD 20u''
2	GOLD 10u''	6	GOLD 30u''

GENERAL TOLERANCE		DWG NO.	A0422-001	APPD:	WIND	Scale	1:1
X,±0.45	x,°±5°	Title	MICRO SIM SOCKET 6PIN 150H (焊接脚内折防浪PIN)	CHKD:		UNIT	mm
.X,±0.35	.x,°±2°	Part NO.	WL-SIM150-090	DR:			
.XX,±0.25	.xx,°±1°	Date	2012/02/29				
.XXX,±0.15	.xxx,°±0.5°	深圳市微连电子有限公司 Shenzhen Welink Electronics Co.,Ltd					
SHEET	1/1						